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U.S. UTILITY Patent Application

PATENT NUMBER and
 ISSUE DATE

APPL NUM 10090094	FILING DATE 03/04/2002	CLASS 257	SUBCLASS 11	GAU 2827 2011	EXAMINER LUAN THAI
** APPLICANTS: Cheng Man Hon; Chow Wai; Keung Ho Wai.					
** CONTINUING DATA VERIFIED: (None) LT					
** FOREIGN APPLICATIONS VERIFIED: (None) LT					
PG-PUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed		<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no		ATTORNEY DOCKET NO	
35 USC 119 conditions met				SC11352HP	
Verified and Acknowledged Examiners's initials		LT			
TITLE : Method of attaching a die to a substrate					

U.S. DEPT. OF COMM. / PAT. & TM. / PTO-4361R9 / 10-1

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		Primary Examiner	DRAWING	
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.
				4, 6
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner	
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